Close Window

Ceramic Capacito	ors			
Fixed Ceramic Capac				
			_	
	R1H105K/2.00		-	
Product Name :				
Multilayer Ceramic Chip Ca	pacitors - Ge	neral Purpose		
View Datasheet				
TDK Series Name : C Se	eries		-	
Application :			_	
Electronics equipment, automation equipment, measurement equipment,	Mobile communica Automotive electr Hybrid ICs,			
Charge pump, etc.				
runction : It has no polarity. High relia	bility is guaranteed	l It can be adapted		
for various circuit such as t through.			~	
Description : Small Size High Capacitanc	e Multilaver Ceram	ic Chin Canacitor It		
has no polarity. High reliabi			< Prev No PDF A	vailable Next >
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	-			
	erty Name		Property Description	
Product Lifecycle Stage		Production		
Part Number Replacement		No Data Available.		
Lead (Pb) Free		Yes		
Surface Mount		Yes		
EIA Size Code		1210		
Size Code		3225		
Body Length (L)		Min 3 mm		
Body Length (L)		Nom 3.2 mm		
Body Length (L)		Max 3.4 mm		
Body Breadth (W)		Min 2.2 mm		
Body Breadth (W)		Nom 2.5 mm		
Body Breadth (W)		Max 2.8 mm		
Body Height (T)		Min 1.8 mm		
Body Height (T)		Nom 2 mm		
Body Height (T)		Max 2.2 mm		
Terminal Width (B)		Min 0.2 mm		
Terminal Spacing (G)		Min 1 mm		
Temperature Characteristics		X7R		
Temperature Characteristic		Min -15 %		
		Max 15 %		
Category Temperature Rang	e	Min - 55 C		
		Max 125 C		
Rated Voltage Code		1H		
Rated Voltage		Max 50 V		
Rated Voltage Classification		DC		
Withstanding Voltage		Nom 125 V		
Withstanding Voltage Class		DC	_	
Rated Capacitance		•	۶F	
Capacitance Tolerance Code		K		
Capacitance Tolerance (Valu	ie)	Min No Data Avail		
		Max No Data Ava	ilable.	
Capacitance Tolerance (%)		Min -10 %		
•		Max 10 %		
Q		Min No Data Avail		
Measurement Frequency of	Q	Nom No Data Ava	ilable.	
Insulation Resistance		Min 500 MOhm		
Dissipation Factor		Max No Data Ava	ilable.	
Frequency of Dissipation Fac	ctor	Nom 1 kHz		
Soldering Method		Reflow, Manual		
Storage Temperature Range		Min 5 Cel Max 40 Cel		
Packing		Blister (Plastic)Ta	ping [180mm Reel]	
Minimum Package Qty		Nom 1000 Pcs		
Minimum Order Qty		Nom 1000 Pcs		
Return Status		STD		
reflects an overview of the proc information, please refer to TDD warranted to meet any specific in TDK's general product speci	duct characteri K's general product spe ations of any intermedi fication. Note also that for use in , or permitted	e purposes only and is subject to chang istics/performance for the particular part ecification. Please note ate or end user different from or in addit this standard part has not been speciall to be resold for, specialized application lectively, "Excluded Applications").	number. For product specification that this standard part is not desig ion to the y designed or manufactured for,	